

# **OptiMOS®-T2 Power-Transistor**

# AEC<sup>0</sup> RoH

# **Product Summary**

$V_{ m DS}$	100	V
R <sub>DS(on),max</sub> (SMD version)	5.0	mΩ
$I_{D}$	120	Α

#### **Features**

• N-channel - Normal Level - Enhancement mode

AEC Q101 qualified

• MSL1 up to 260°C peak reflow

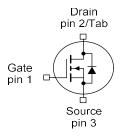
• 175°C operating temperature

RoHS compliant

• 100% Avalanche tested

PG-TO263-3-2	PG-TO262-3-1	PG-TO220-3-1
Tab  Glatter	Tab	Tab

Туре	Package	Marking
IPB120N10S4-05	PG-TO263-3-2	4N1005
IPI120N10S4-05	PG-TO262-3-1	4N1005
IPP120N10S4-05	PG-TO220-3-1	4N1005



# **Maximum ratings,** at $T_i$ =25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I <sub>D</sub>	$T_{\rm C}$ =25°C, $V_{\rm GS}$ =10 $V^{1)}$	120	А
		$T_{\rm C}$ =100°C, $V_{\rm GS}$ =10 $V^{2)}$	95	
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	T <sub>C</sub> =25°C	480	
Avalanche energy, single pulse <sup>2)</sup>	E <sub>AS</sub>	I <sub>D</sub> =60A	330	mJ
Avalanche current, single pulse	IAS	-	120	А
Gate source voltage	V <sub>GS</sub>	-	±20	V
Power dissipation	P tot	T <sub>C</sub> =25°C	190	W
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-	-55 <b>+</b> 175	°C



# IPB120N10S4-05 IPI120N10S4-05, IPP120N10S4-05

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal characteristics <sup>2)</sup>						
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	-	0.8	K/W
Thermal resistance, junction - ambient, leaded	R <sub>thJA</sub>	-	-	-	62	
SMD version, device on PCB	R <sub>thJA</sub>	minimal footprint	-	-	62	
		6 cm <sup>2</sup> cooling area <sup>3)</sup>	-	-	40	1

# **Electrical characteristics,** at $T_j$ =25 °C, unless otherwise specified

#### **Static characteristics**

Drain-source breakdown voltage	$V_{(BR)DSS}$ $V_{GS}$ =0V, $I_D$ = 1mA		100	-	-	V
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 120 \mu {\rm A}$	2.0	2.7	3.5	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V	-	0.1	1	μA
		$V_{\rm DS}$ =100V, $V_{\rm GS}$ =0V, $T_{\rm j}$ =125°C <sup>2)</sup>	-	10	100	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V	-	-	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =100A	-	4.5	5.3	mΩ
		V <sub>GS</sub> =10V, I <sub>D</sub> =100A, SMD version	-	4.2	5.0	

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Parameter	Symbol Conditions			Values		
			min.	typ.	max.	
Dynamic characteristics <sup>2)</sup>						
Input capacitance	C iss		-	5030	6540	pF
Output capacitance	C <sub>oss</sub>	$V_{\rm GS}$ =0V, $V_{\rm DS}$ =25V, $f$ =1MHz	-	1600	2080	1
Reverse transfer capacitance	C <sub>rss</sub>	]	-	100	200	1
Turn-on delay time	t <sub>d(on)</sub>		-	15	-	ns
Rise time	t <sub>r</sub>	V <sub>DD</sub> =50V, V <sub>GS</sub> =10V,	-	10	-	1
Turn-off delay time	t <sub>d(off)</sub>	$I_{\rm D}$ =120A, $R_{\rm G}$ =3.5 $\Omega$	-	30	-	1
Fall time	t <sub>f</sub>		-	35	-	1
Gate Charge Characteristics <sup>2)</sup>			-			
Gate to source charge	Q <sub>gs</sub>		-	24	31	nC
Gate to drain charge	Q <sub>gd</sub>	$V_{DD}$ =80V, $I_{D}$ =120A, $V_{GS}$ =0 to 10V	-	14	28	
Gate charge total	Q <sub>g</sub>		-	70	91	]
Gate plateau voltage	V <sub>plateau</sub>		-	4.9	-	V
Reverse Diode						
Diode continous forward current <sup>2)</sup>	Is	T -25°C	-	-	120	А
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	- T <sub>C</sub> =25°C	-	-	480	
Diode forward voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>F</sub> =100A, T <sub>j</sub> =25°C	-	1.0	1.3	V
Reverse recovery time <sup>2)</sup>	t <sub>rr</sub>	$V_R$ =50V, $I_F$ =50A, $di_F/dt$ =100A/µs	-	65	-	ns
Reverse recovery charge <sup>2)</sup>	Q <sub>rr</sub>	1	-	130	-	nC

 $<sup>^{1)}</sup>$  Current is limited by bondwire; with an  $R_{\rm thJC}$  = 0.8K/W the chip is able to carry 134A at 25°C.

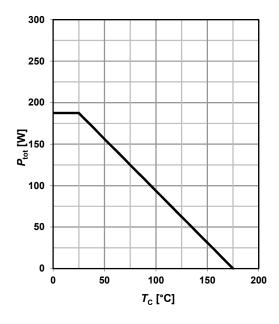
<sup>&</sup>lt;sup>2)</sup> Specified by design. Not subject to production test.

 $<sup>^{3)}</sup>$  Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.



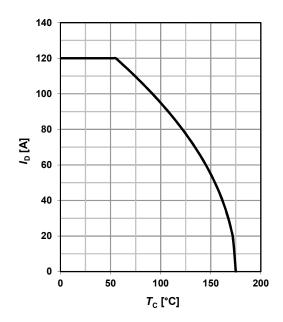
# 1 Power dissipation

$$P_{\text{tot}} = f(T_{\text{C}}); V_{\text{GS}} = 10 \text{ V}$$



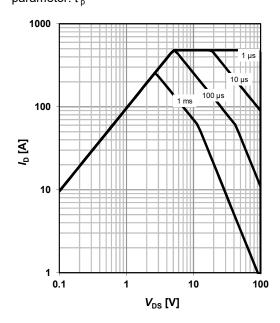
#### 2 Drain current

$$I_D = f(T_C)$$
;  $V_{GS} = 10 \text{ V}$ ; SMD



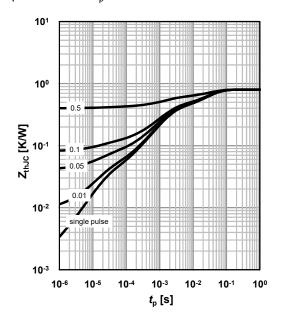
# 3 Safe operating area

$$I_D = f(V_{DS}); T_C = 25 \text{ °C}; D = 0; SMD$$
  
parameter:  $t_p$ 



#### 4 Max. transient thermal impedance

$$Z_{thJC} = f(t_p)$$
  
parameter:  $D = t_p/T$ 





#### 5 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 25 \text{ °C}; SMD$ 

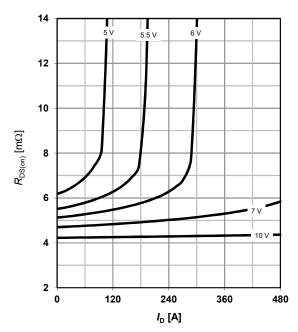
parameter:  $V_{\rm GS}$ 

# 360 360 10V 7V 6V 120 0 1 2 3 4 5

#### 6 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(I_D); T_j = 25 \text{ °C}; SMD$ 

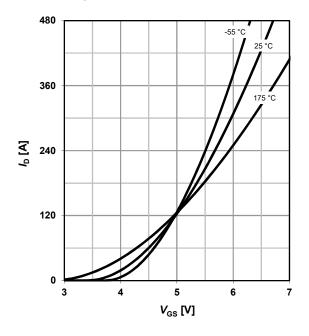
parameter:  $V_{\rm GS}$ 



# 7 Typ. transfer characteristics

 $I_{\rm D} = f(V_{\rm GS}); \ V_{\rm DS} = 6V$ 

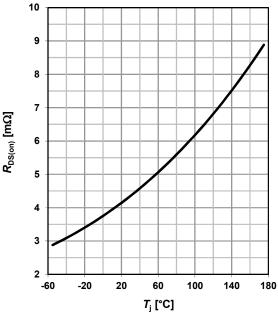
parameter:  $T_{\rm j}$ 



# 8 Typ. drain-source on-state resistance

 $R_{DS(on)} = f(T_j); I_D = 100 \text{ A}; V_{GS} = 10 \text{ V}; SMD$ 

 $\alpha = 0.4$ 





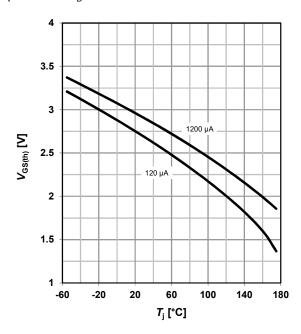
# 9 Typ. gate threshold voltage

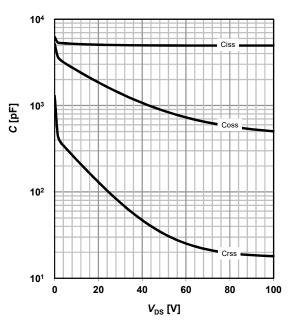
$$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}$$

parameter: I<sub>D</sub>

# 10 Typ. capacitances

$$C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$$

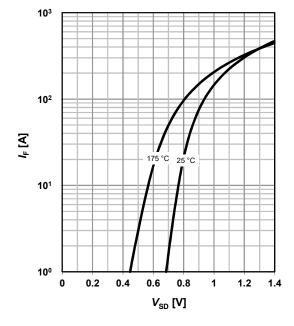




# 11 Typical forward diode characteristicis

$$I_F = f(V_{SD})$$

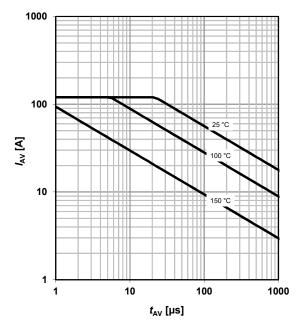
parameter:  $T_{\rm j}$ 



#### 12 Avalanche characteristics

$$I_{AS} = f(t_{AV})$$

parameter: T<sub>j(start)</sub>

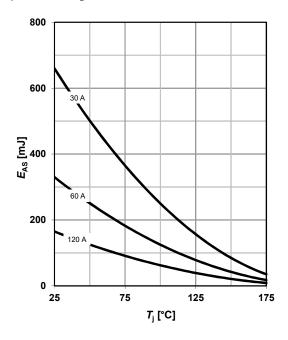




# 13 Avalanche energy

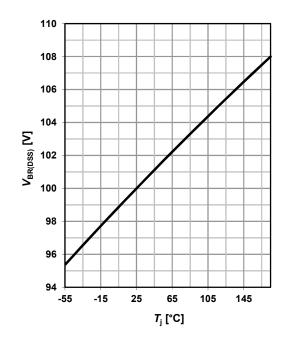
 $E_{AS} = f(T_j)$ 

parameter:  $I_{\rm D}$ 



#### 14 Drain-source breakdown voltage

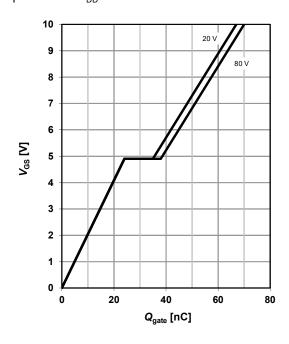
 $V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$ 



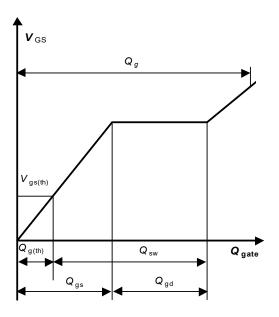
# 15 Typ. gate charge

 $V_{GS} = f(Q_{gate}); I_D = 120 A pulsed$ 

parameter:  $V_{\rm DD}$ 



#### 16 Gate charge waveforms





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# IPB120N10S4-05 IPI120N10S4-05, IPP120N10S4-05

# **Revision History**

Version	Date	Changes
Revision 1.0	2014-07-01	Data Sheet Revision 1.0
Revision 1.1	2022-07-28	Diagram 8 Typ. drain-source on- state resistance: used α value clarified